

## Bias Resistor Transistor

### PNP Silicon Surface Mount Transistor with Monolithic Bias Resistor Network

- Applications

Inverter, Interface, Driver

- Features

- 1) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see equivalent circuit).
  - 2) The bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input. They also have the advantage of almost completely eliminating parasitic effects.
  - 3) Only the on / off conditions need to be set for operation, making the device design easy.
- We declare that the material of product compliance with RoHS requirements.
  - S - Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

- **Absolute maximum ratings (Ta=25°C)**

Parameter	Symbol	Limits	Unit
Collector-base voltage	V <sub>CBO</sub>	-50	V
Collector-emitter voltage	V <sub>C EO</sub>	-50	V
Emitter-base voltage	V <sub>EBO</sub>	-5	V
Collector current	I <sub>C</sub>	-500	mA
Collector power dissipation	P <sub>d</sub> *	200	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

\* Each pin mounted on the recommended land

#### DEVICE MARKING AND RESISTOR VALUES

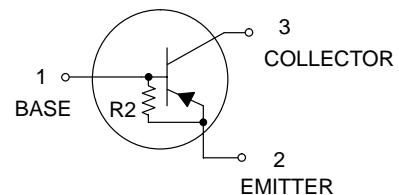
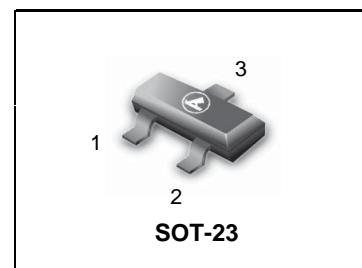
Device	Marking	R1 (K)	R2 (K)	Shipping
LDTB114GLT1G S-LDTB114GLT1G	K7	—	10	3000/Tape & Reel
LDTB114GLT3G S-LDTB114GLT3G	K7	—	10	10000/Tape & Reel

- **Electrical characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV <sub>CBO</sub>	-50	—	—	V	I <sub>C</sub> = -50μA
Collector-emitter breakdown voltage	BV <sub>C EO</sub>	-50	—	—	V	I <sub>C</sub> = -1mA
Emitter-base breakdown voltage	BV <sub>EBO</sub>	-5	—	—	V	I <sub>E</sub> = -720μA
Collector cutoff current	I <sub>CBO</sub>	—	—	-0.5	μA	V <sub>CB</sub> = -50V
Emitter cutoff current	I <sub>EBO</sub>	—	—	-580	μA	V <sub>EB</sub> = -4V
Collector-emitter saturation voltage	V <sub>C E(sat)</sub>	—	—	-0.3	V	I <sub>C</sub> /I <sub>B</sub> = -50mA/-2.5mA
DC current transfer ratio	h <sub>FE</sub>	56	—	—	—	I <sub>C</sub> = -50mA , V <sub>CE</sub> = -5V
Input resistance	R <sub>2</sub>	7	10	13	kΩ	—
Transition frequency	f <sub>T</sub> *	—	200	—	MHz	V <sub>CE</sub> = -10V , I <sub>E</sub> =50mA , f=100MHz

\*Characteristics of built-in transistor

**LDTB114GLT1G  
S-LDTB114GLT1G**



**LDTB114GLT1G;S-LDTB114GLT1G**

## ●Electrical characteristic curves

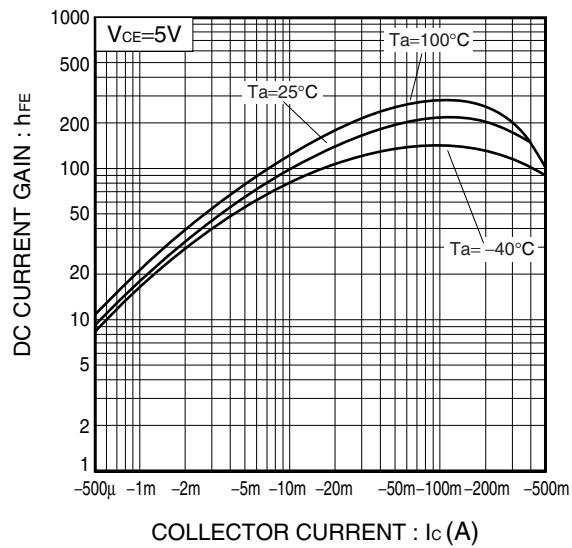


Fig.1 DC current transfer ratio  
vs. Collector current

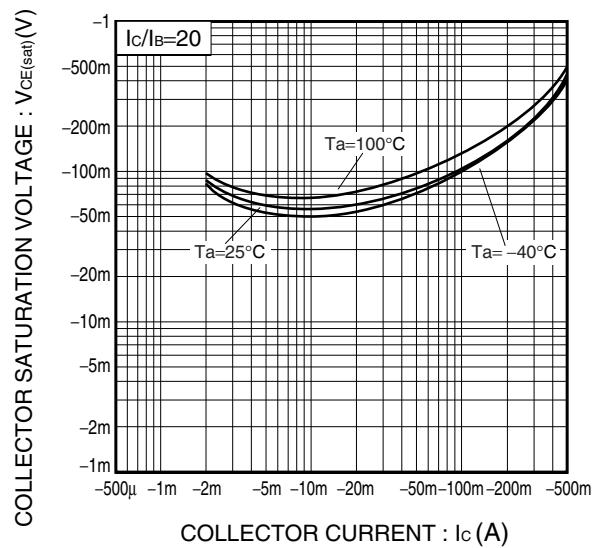
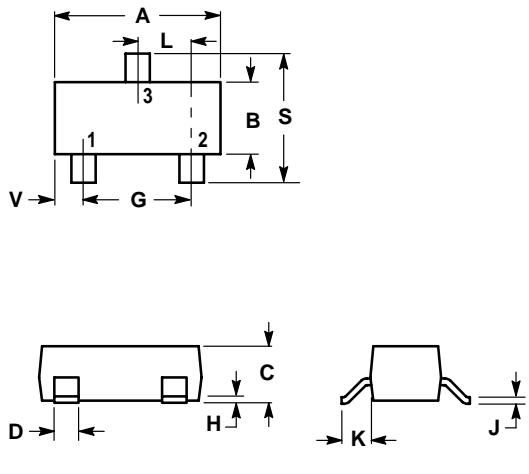


Fig.2 Collector-Emitter saturation voltage  
vs. Collector current

**LDTB114GLT1G;S-LDTB114GLT1G**
**SOT-23**
**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

